

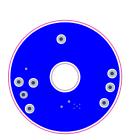
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00578 REU: rev001 SUN REU: Not In VersionControl
LAYER NAME = Top Overlay	TID #: ChangeMe!
PLOT NAME = Top Overlay	GENERATED : 6/9/2015 3:29:11 PM TEXAS INSTRUMENTS



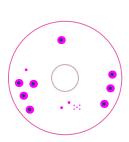
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00578 REU: rev001 SUN REU: Not In VersionControl
LAYER NAME = Top Solder	TID #: ChangeMe!
PLOT NAME = Top Solder Mask	GENERATED : 6/9/2015 3:29:12 PM TEXAS INSTRUMENTS



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00578 REV: rev001 SUN REV: Not In Ver:	sionControl
LAYER NAME = Top Layer	TID #: ChangeMe!	
PLOT NAME = Top Layer	GENERATED : 6/9/2015 3:29:12 PM TEXAS IN	ISTRUMENTS



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00578 REU: rev001 SUN REU: Not I	n VersionControl
LAYER NAME = Bottom Layer	TID #: ChangeMe!	
PLOT NAME = Bottom Layer	GENERATED : 6/9/2015 3:29:13 PM TEX	XAS INSTRUMENTS



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00578 REV: rev001 SUN REV: Not In VersionControl
LAYER NAME = Bottom Solder	TID #: ChangeMe!
PLOT NAME = Bottom Solder Mask	GENERATED : 6/9/2015 3:29:13 PM TEXAS INSTRUMENTS

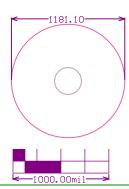


ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00578	REV: rev001 S	SUN REV: Not In VersionControl
LAYER NAME = Bottom Overlay	TID #: ChangeMe!	•	
PLOT NAME = Bottom Overlay	GENERATED : 6/9/2015	3:29:14 PM	TEXAS INSTRUMENTS

Symbol	Quantity	Finished Hole Size	Plated	Hole Type
0	5	5,91mil (0,150mm)	РТН	Round
▽	3	14.00mil (0.356mm)	PTH	Round
Ħ	7	37.99mil (0.965mm)	РТН	Round
0	1	38.00mil (0.965mm)	PTH	Round
	16 Total			



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00578 REV: rev001 SUN REV	: Not In VersionControl
LAYER NAME = Drill Drawing	TID #: ChangeMe!	
PLOT NAME = Drill Drawing	GENERATED : 6/9/2015 3:29:15 PM	TEXAS INSTRUMENTS



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00578 REV: rev001 SVN REV	: Not In VersionControl
LAYER NAME = M2 Board Dimensions	TID #: ChangeMe!	
PLOT NAME = Board Dimensions	GENERATED : 6/9/2015 3:29:15 PM	TEXAS INSTRUMENTS

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